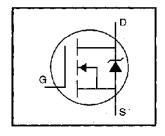
# International Rectifier

# IRF510PbF

#### HEXFET® Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- 175°C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

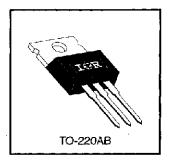


$$V_{DSS} = 100V$$
 $R_{DS(on)} = 0.54\Omega$ 
 $I_D = 5.6A$ 

#### Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.



#### **Absolute Maximum Ratings**

	Parameter	Max.	Units		
lo @ Tc = 25°C	Continuous Drain Current, Vcs @ 10 V	5.6			
lo @ Tc = 100°C	Continuous Drain Current, V <sub>GS</sub> @ 10 V	4.0	Α		
I <sub>DM</sub>	Pulsed Drain Current ①	20			
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Power Dissipation	43	W		
	Linear Derating Factor	0.29	W/°C		
V <sub>GS</sub>	Gate-to-Source Voltage	±20	V		
Eas	Single Pulse Avalanche Energy ②	100	mJ		
IAR	Avalanche Current ①	5.6	Α		
EAR	Repetitive Avalanche Energy ①	4.3	mJ		
dv/dt	Peak Diode Recovery dv/dt ③	5.5	V/ns		
TJ	Operating Junction and	-55 to +175	_		
Tsra	Storage Temperature Range		∖ °C		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)			
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1 N•m)			

#### **Thermal Resistance**

	Parameter	Min.	Тур.	Max.	Units
Reuc	Junction-to-Case	<del>-</del>		3.5	
Recs	Case-to-Sink, Flat, Greased Surface		0.50	_	°C/W
Raja	Junction-to-Ambient			62	r İ

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#### Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	100	_	_	V	V <sub>GS</sub> =0V, I <sub>D</sub> = 250μA	
ΔV <sub>(BR)DSS</sub> /ΔT <sub>J</sub>	Breakdown Voltage Temp. Coefficient	· —	0.12	_	V/°C	Reference to 25°C,   <sub>D</sub> = 1mA	
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance		_	0.54	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =3.4A ④	
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.0		4.0	٧	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 250μA	
grs .	Forward Transconductance	1.3	_		S	V <sub>DS</sub> =50V, I <sub>D</sub> =3.4A @	
_	Dunin to Survey Looks as Comment	_	_	25		V <sub>DS</sub> =100V, V <sub>GS</sub> =0V	
IDSS	Drain-to-Source Leakage Current		_	250	· μА	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V, T <sub>J</sub> =150°C	
1	Gate-to-Source Forward Leakage	-	_	100	- nA	V <sub>GS</sub> =20V	
less	Gate-to-Source Reverse Leakage	_		-100	1177	V <sub>GS</sub> =-20V	
$Q_g$	Total Gate Charge			8.3		I <sub>D</sub> =5.6A	
Qgs	Gate-to-Source Charge		_	2.3	nC	V <sub>DS</sub> =80V	
$Q_{gd}$	Gate-to-Drain ("Miller") Charge	—	_	3.8	!	V <sub>GS</sub> =10V See Fig. 6 and 13 @	
t <sub>d(on)</sub>	Turn-On Delay Time	_	6.9			V <sub>DD</sub> =50V	
tr	Rise Time	l —	16	-	ns	I <sub>D</sub> =5.6A	
t <sub>d(off)</sub>	Turn-Off Delay Time	·—	15		]	R <sub>G</sub> =24Ω	
tı	Fall Time	-	9.4	_		R <sub>D</sub> =8.4Ω See Figure 10 ⊕	
LD	Internal Drain Inductance	-	4.5		nH	Between lead, 6 mm (0.25in.)	
Ls	Internal Source Inductance		7.5	_	1111	from package and center of life contact	
Ciss	Input Capacitance	<u> </u>	180	-		V <sub>GS</sub> =0V	
Coss	Output Capacitance	-	81		рF	V <sub>DS</sub> =25V	
Crss	Reverse Transfer Capacitance		15	_	]	f=1.0MHz See Figure 5	

#### Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
al	Continuous Source Current (Body Diode)	-	_	5.6	А	MOSFET symbol showing the
Ism	Pulsed Source Current (Body Diode) ①		_	20	Î	integral reverse p-n junction diode.
V <sub>SD</sub>	Diode Forward Voltage	_		2.5	V	T <sub>J</sub> =25°C, I <sub>S</sub> =5.6A, V <sub>GS</sub> =0V ①
t <sub>rr</sub>	Reverse Recovery Time		100	200	ns	T <sub>J</sub> =25°C, I <sub>F</sub> =5.6A
Qır	Reverse Recovery Charge	_	0.44	0.88	μC	di/dt=100A/μs ⊛
tan	Forward Turn-On Time	Intrins	intrinsic turn-on time is neglegible (turn-on is dominated by Ls+LD)			

#### Notes:

- Repetitive rating; pulse width limited by max, junction temperature (See Figure 11)
- ③ Isp≤5.6A, di/dt≤75A/ $\mu$ s, Vpp≤V(BR)pss, TJ≤175°C
- ② V<sub>DD</sub>=25V, starting T<sub>J</sub>=25°C, L=4.8mH R<sub>G</sub>=25 $\Omega$ , I<sub>AS</sub>=5.6A (See Figure 12)
- 4 Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$ 2%.

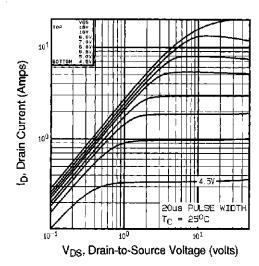


Fig 1. Typical Output Characteristics, T<sub>C</sub>=25°C

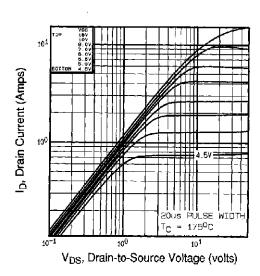


Fig 2. Typical Output Characteristics, T<sub>C=175°C</sub>

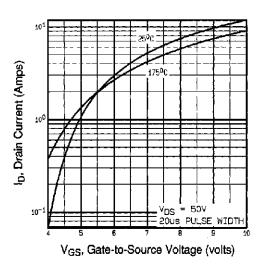


Fig 3. Typical Transfer Characteristics

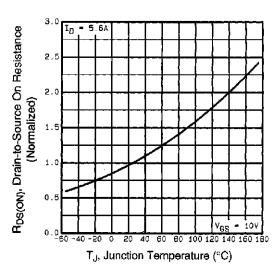


Fig 4. Normalized On-Resistance Vs. Temperature

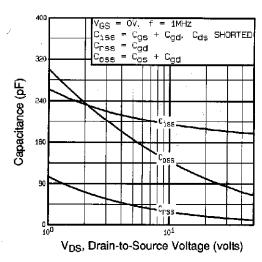


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

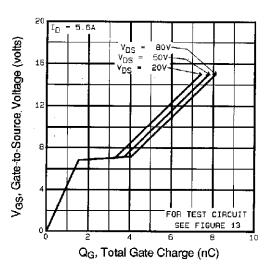


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

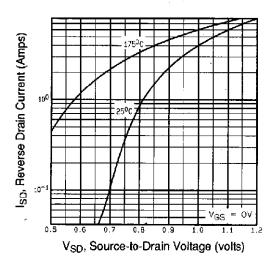


Fig 7. Typical Source-Drain Diode Forward Voltage

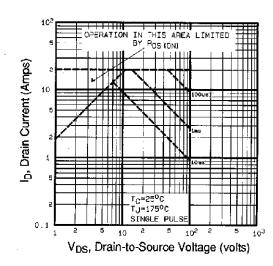


Fig 8. Maximum Safe Operating Area

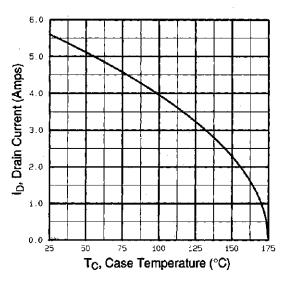


Fig 9. Maximum Drain Current Vs. Case Temperature

# IRF510PbF Vos Vos D.U.T. Pulse Width ≤ 1μs Duty Factor ≤ 0.1%

Fig 10a. Switching Time Test Circuit

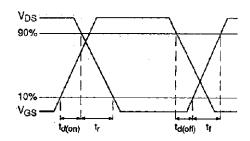


Fig 10b. Switching Time Waveforms

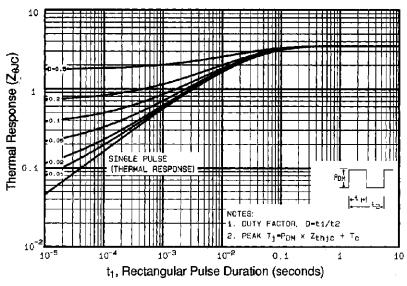


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

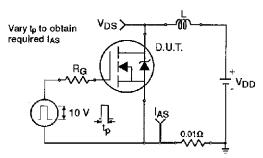


Fig 12a. Unclamped Inductive Test Circuit

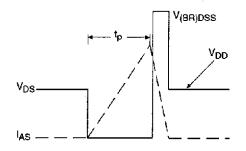


Fig 12b. Unclamped Inductive Waveforms

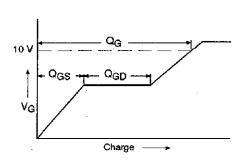


Fig 13a. Basic Gate Charge Waveform

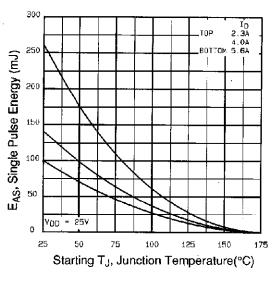


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

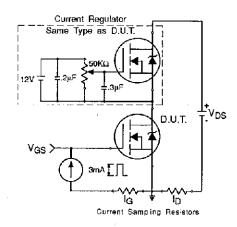


Fig 13b. Gate Charge Test Circuit

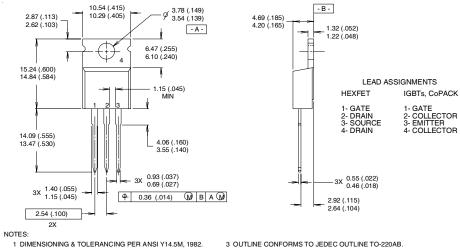
Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit - See page 1505



# IRF510PbF

### TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



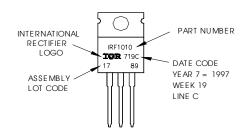
- 1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982.
- 2 CONTROLLING DIMENSION: INCH
- 4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

## TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010 LOT CODE 1789

ASSEMBLED ON WW 19, 1997 IN THE ASSEMBLY LINE "C"

Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.



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